PSMN4R5-40PS



N-channel 40 V 4.6 mΩ standard level MOSFET

Rev. 02 — 25 June 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive sources

1.3 Applications

- DC-to-DC convertors
- Load switching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	40	V
I_D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u>		-	-	100	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	148	W
Dynamic characteristics							
Q_{GD}	gate-drain charge	V_{GS} = 10 V; I_D = 25 A; V_{DS} = 20 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	8.8	-	nC
Static characteristics							
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 13}}{\text{Figure 15}};$	[1]	-	3.9	4.6	mΩ
-							

^[1] Measured 3 mm from package.



2. Pinning information

Table 2. Pinning information

_			
Symbol	Description	Simplified outline	Graphic symbol
G	gate		_
D	drain	mb	D
S	source		$G \longrightarrow A$
D	mounting base; connected to drain	1 2 3	mbb076 S
		SOT78 (TO-220AB;SC-46)	
	G D S	G gate D drain S source D mounting base; connected to	G gate D drain S source D mounting base; connected to drain 1 2 3 SOT78

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN4R5-40PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB $$	SOT78			

4. Limiting values

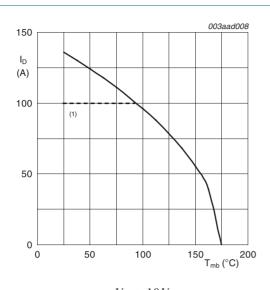
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$	-	40	V
V_{DGR}	drain-gate voltage	$T_j \ge 25$ °C; $T_j \le 175$ °C; $R_{GS} = 20$ kΩ	-	40	V
V_{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	-	96	Α
		V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u>	-	100	Α
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	545	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	148	W
T _{stg}	storage temperature		-55	175	°C
T _j	junction temperature		-55	175	°C
Source-dr	ain diode				
Is	source current	$T_{mb} = 25 ^{\circ}\text{C}$	-	100	Α
I _{SM}	peak source current	$t_p \le 10 \mu\text{s}; \text{ pulsed}; T_{mb} = 25 ^{\circ}\text{C}$	-	545	Α
Avalanche	e ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 100 A; V_{sup} ≤ 40 V; unclamped; R_{GS} = 50 Ω	-	152	mJ

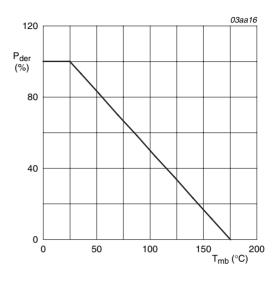
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 $V_{GS} \geq 10\,V$ (1) Capped at 100 A due to package.

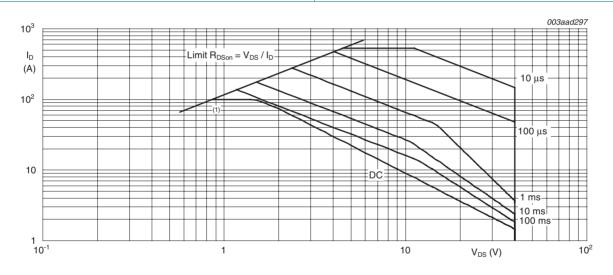
Continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

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Fig 2. Normalized total power dissipation as a function of mounting base temperature



 $T_{mb} = 25 \,^{\circ}C; I_{DM}$ is single pulse (1) Capped at 100 A due to package.

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.65	1	K/W

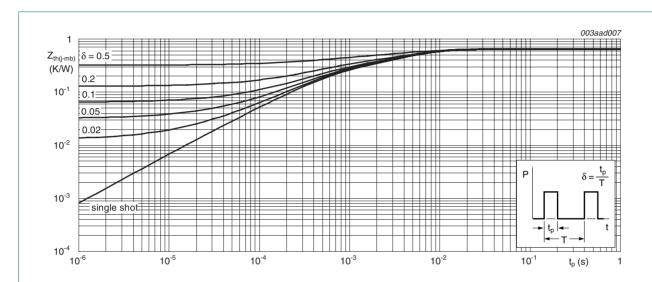


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values

6. Characteristics

Table 6. Characteristics

Tested to JEDEC standards where applicable.

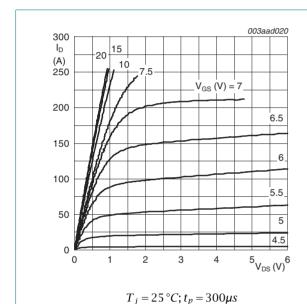
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
$V_{(BR)DSS}$	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^{\circ}C$		36	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$		40	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS} ; T_j = -55 °C; see Figure 11; see Figure 12		-	-	4.6	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 175$ °C; see Figure 11; see Figure 12		1	-	-	V
		I_D = 1 mA; V_{DS} = V_{GS} ; T_j = 25 °C; see Figure 11; see Figure 12		2	3	4	V
I _{DSS}	drain leakage current	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μΑ
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 125 °C		-	-	60	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
		$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 100 \text{ °C}; \text{see}$ Figure 13		-	-	6.7	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 25 ^{\circ}\text{C}; \text{see}$ Figure 13;	[1]	-	3.9	4.6	mΩ
R_{G}	internal gate resistance (AC)	f = 1 MHz		-	0.97	-	Ω
Dynamic o	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V$		-	35	-	nC
		$I_D = 25 \text{ A}$; $V_{DS} = 20 \text{ V}$; $V_{GS} = 10 \text{ V}$; see Figure 14; see Figure 15		-	42.3	-	nC
Q_{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V}; \text{see}$		-	13.8	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	Figure 14; see Figure 15		-	7.9	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	5.9	-	nC
Q_{GD}	gate-drain charge			-	8.8	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; \text{ see } \underline{\text{Figure 14}}$		-	4.8	-	V
C _{iss}	input capacitance	$V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$		-	2683	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 16</u>		-	660	-	pF
C _{rss}	reverse transfer capacitance			-	290	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_L = 0.5 Ω ; V_{GS} = 10 V;		-	19	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	23	-	ns
t _{d(off)}	turn-off delay time			-	30	-	ns
t _f	fall time			-	9	-	ns

Table 6. Characteristics ... continued

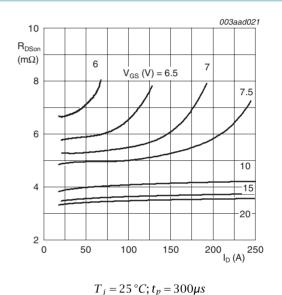
Tested to JEDEC standards where applicable.

		• •				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dr	ain diode					
V _{SD}	source-drain voltage	$I_S = 25 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ °C}$; see Figure 17	-	0.75	1.2	V
t _{rr}	reverse recovery time	I_S = 50 A; dI_S/dt = -100 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V	-	40	-	ns
Q _r	recovered charge	$I_S = 50 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V}; V_{DS} = 20 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	33	-	nC

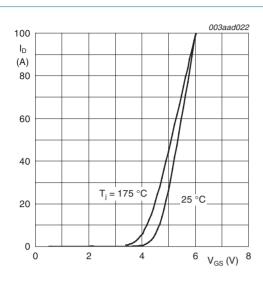
[1] Measured 3 mm from package.



Output characteristics: drain current as a Fig 5. function of drain-source voltage; typical values

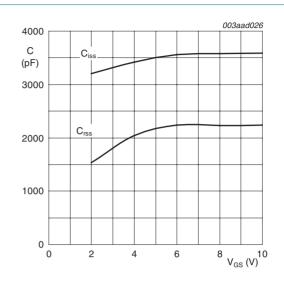


Drain-source on-state resistance as a function Fig 6. of drain current; typical values



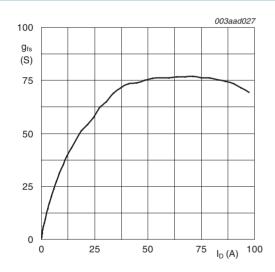
 $V_{DS} = 15V$

Fig 7. Transfer characteristics: drain current as a function of gate-source voltage; typical values



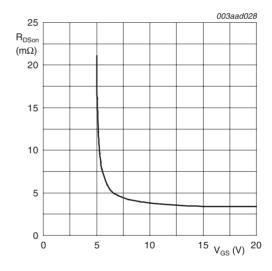
 $V_{DS} = 0V; f = 1MHz$

Fig 8. Input and reverse transfer capacitances as a function of gate-source voltage; typical values



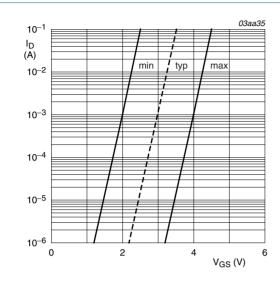
 $T_j = 25 \,{}^{\circ}C; V_{DS} = 15 \, V$

Fig 9. Forward transconductance as a function of drain current; typical values



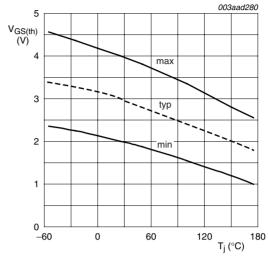
 $T_i = 25 \,^{\circ}C; I_D = 25A$

Fig 10. Drain-source on-state resistance as a function of gate-source voltage; typical values



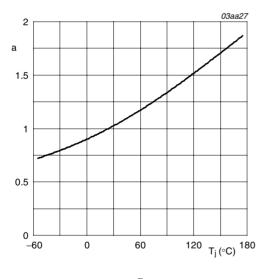
 $T_{j} = 25 \,^{\circ}C; V_{DS} = 5V$

Fig 11. Sub-threshold drain current as a function of gate-source voltage



$$I_D = 1 \, mA; V_{DS} = V_{GS}$$

Fig 12. Gate-source threshold voltage as a function of junction temperature



 $a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$

Fig 13. Normalized drain-source on-state resistance factor as a function of junction temperature

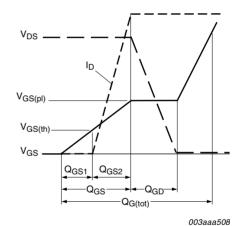
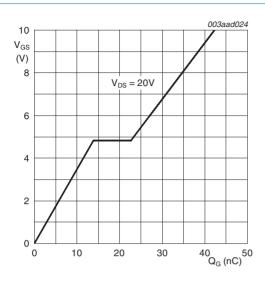
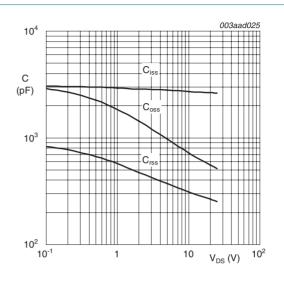


Fig 14. Gate charge waveform definitions



 $T_j = 25 \,^{\circ}C; I_D = 25A$

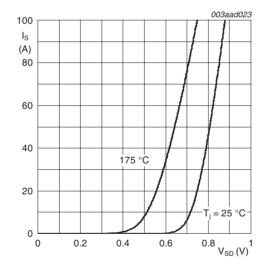
Fig 15. Gate-source voltage as a function of gate charge; typical values



 $V_{GS} = 0V; f = 1MHz$

Fig 16. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

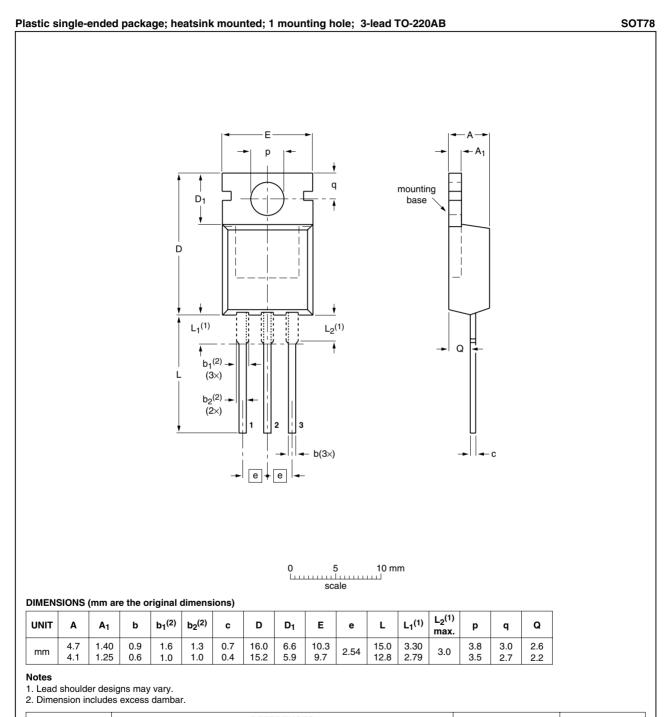
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 $V_{GS} = 0 V$

Fig 17. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

7. Package outline



OUTLINE			REFER	ENCES	EUROPEAN	
	VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
	SOT78		3-lead TO-220AB	SC-46		08-04-23 08-06-13

Fig 18. Package outline SOT78 (TO-220AB)

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N-channel 40 V 4.6 mΩ standard level MOSFET

Revision history

Table 7. **Revision history**

Product data sheet

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN4R5-40PS_2	20090625	Product data sheet	-	PSMN4R5-40PS_1
Modifications:	 Data sheet 	status changed from obj	ective to product.	
	 Various cha 	anges to content.		
PSMN4R5-40PS_1	20090507	Objective data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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